



DESIGNED BY: HIEU DUONG

LAYER STACK-UP - ALL DIMENSIONS IN MILS			
		50ohm SINGLE ENDED IMPEDANCE CONTROL +/- 10%	100ohm DIFFERENTIAL IMPEDANCE CONTROL +/- 10%
LAYERS	CU WGT (OZ)	TRACE WIDTH	TRACE WIDTH/SPACE
LAYER 1 - SIGNAL PRIMARY SIDE	HALF + PLATING	12	8 / 8
LAYER 2 - GROUND PLANE	1		
LAYER 3 - SPLIT PWR PLANE	1		
LAYER 4 - SIGNAL SECONDARY SIDE	HALF + PLATING	12	8 / 8

